## **HEF4060B**

14-stage ripple-carry binary counter/divider and oscillatorRev. 10 — 8 November 2021Product data sheet

### 1. General description

The HEF4060B is a 14-stage ripple-carry counter/divider and oscillator with three oscillator terminals (RS, REXT and CEXT), ten buffered parallel outputs (Q3 to Q9 and Q11 to Q13) and an overriding asynchronous master reset (MR). The oscillator configuration allows design of either RC or crystal oscillator circuits. The oscillator may be replaced by an external clock signal at input RS. In this case, keep the oscillator pins (REXT and CEXT) floating. The counter advances on the HIGH-to-LOW transition of RS. A HIGH level on MR clears all counter stages and forces all outputs LOW, independent of the other input conditions. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{DD}$ .

### 2. Features and benefits

- Wide supply voltage range from 3.0 V to 15.0 V
- CMOS low power dissipation
- High noise immunity
- Complies with JEDEC standard JESD 13-B
- Tolerant of slow clock rise and fall times
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from -40 ° C to +85 °C

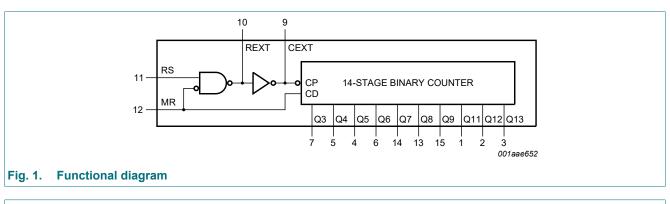
### 3. Ordering information

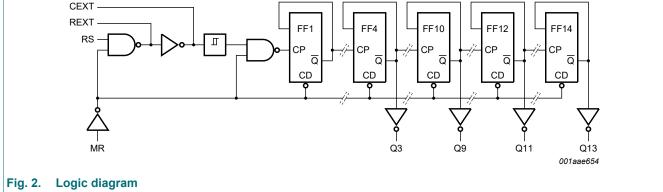
#### Table 1. Ordering information

Type number	Package					
	Temperature range	Name	Description	Version		
HEF4060BT	-40 °C to +85 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1		
HEF4060BTT	-40 °C to +85 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1		

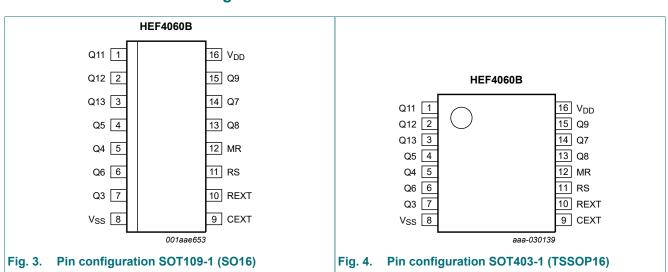
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### 4. Functional diagram





### 5. Pinning information



### 5.1. Pinning

### 5.2. Pin description

Table 2. Pin description						
Symbol	Pin	Description				
Q11 to Q13	1, 2, 3	counter output				
Q3 to Q9	7, 5, 4, 6, 14, 13, 15	counter output				
V <sub>SS</sub>	8	ground supply voltage				
CEXT	9	external capacitor connection				
REXT	10	oscillator pin				
RS	11	clock input/oscillator pin				
MR	12	master reset				
V <sub>DD</sub>	16	supply voltage				

### 6. Functional description

#### Table 3. Function table

H = HIGH voltage level; L = LOW voltage level;  $\uparrow = LOW$ -to-HIGH clock transition;  $\downarrow HIGH$ -to-LOW clock transition.

Input	Output		
RS MR C		Q3 to Q9 and Q11 to Q13	
1	L	no change	
$\downarrow$	L	count	
X	Н	L	

### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DD</sub>	supply voltage		-0.5	+18	V
I <sub>IK</sub>	input clamping current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V <sub>DD</sub> + 0.5	V
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
I <sub>I/O</sub>	input/output current		-	±10	mA
I <sub>DD</sub>	supply current		-	50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+85	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> -40 °C to +85 °C	-	500	mW
Р	power dissipation	per output	-	100	mW

### 8. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DD</sub>	supply voltage		3	-	15	V
VI	input voltage		0	-	V <sub>DD</sub>	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C
$\Delta t/\Delta V$ input transition rise and fall		input MR				
	rate	V <sub>DD</sub> = 5 V	-	-	3.75	µs/V
		V <sub>DD</sub> = 10 V	-	-	0.5	µs/V
		V <sub>DD</sub> = 15 V	-	-	0.08	µs/V

#### Table 5. Recommended operating conditions

### 9. Static characteristics

#### Table 6. Static characteristics

 $V_{SS} = 0 V$ ;  $V_{I} = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>DD</sub>	T <sub>amb</sub> = -40 °C		T <sub>amb</sub> = 25 °C		T <sub>amb</sub> = 85 °C		Unit
				Min	Max	Min	Мах	Min	Max	
VIH	HIGH-level input	I <sub>O</sub>   < 1 μΑ	5 V	3.5	-	3.5	-	3.5	-	V
	voltage		10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
V <sub>IL</sub>	LOW-level input	I <sub>O</sub>   < 1 μΑ	5 V	-	1.5	-	1.5	-	1.5	V
	voltage		10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V <sub>OH</sub>	HIGH-level output	I <sub>O</sub>   < 1 μΑ	5 V	4.95	-	4.95	-	4.95	-	V
	voltage		10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V <sub>OL</sub> LOW-le	LOW-level output	I <sub>O</sub>   < 1 μΑ	5 V	-	0.05	-	0.05	-	0.05	V
	voltage		10 V	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	V
I <sub>OH</sub>	HIGH-level output	V <sub>O</sub> = 2.5 V	5 V	-	-1.7	-	-1.4	-	-1.1	mA
	current	V <sub>O</sub> = 4.6 V	5 V	-	-0.52	-	-0.44	-	-0.36	mA
		V <sub>O</sub> = 9.5 V	10 V	-	-1.3	-	-1.1	-	-0.9	mA
		V <sub>O</sub> = 13.5 V	15 V	-	-3.6	-	-3.0	-	-2.4	mA
I <sub>OL</sub>	LOW-level output	V <sub>O</sub> = 0.4 V	5 V	0.52	-	0.44	-	0.36	-	mA
	current	V <sub>O</sub> = 0.5 V	10 V	1.3	-	1.1	-	0.9	-	mA
		V <sub>O</sub> = 1.5 V	15 V	3.6	-	3.0	-	2.4	-	mA
l <sub>l</sub>	input leakage current		15 V	-	±0.3	-	±0.3	-	±1.0	μA
I <sub>DD</sub>	supply current	I <sub>O</sub> = 0 A	5 V	-	20	-	20	-	150	μA
			10 V	-	40	-	40	-	300	μA
			15 V	-	80	-	80	-	600	μA
CI	input capacitance		-	-	-	-	7.5	-	-	pF

### **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

 $T_{amb}$  = 25 °C;  $V_{SS}$  = 0 V;  $C_L$  = 50 pF;  $t_r$  =  $t_f \le$  20 ns; unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>DD</sub>	Extrapolation formula[1]	Min	Тур	Max	Unit
t <sub>pd</sub>	propagation delay	$RS \rightarrow Q3;$	5 V [2]	183 ns + (0.55 ns/pF) C <sub>L</sub>	-	210	420	ns
-		see <u>Fig. 5</u>	10 V	69 ns + (0.23 ns/pF) C <sub>L</sub>	-	80	160	ns
			15 V	42 ns + (0.16 ns/pF) C <sub>L</sub>	-	50	100	ns
		$Qn \rightarrow Qn + 1;$	5 V	-	-	25	50	ns
		see <u>Fig. 5</u>	10 V	-	-	10	20	ns
			15 V	-	-	6	12	ns
		$MR \rightarrow Qn;$	5 V	73 ns + (0.55 ns/pF) C <sub>L</sub>	-	100	200	ns
		HIGH to LOW	10 V	29 ns + (0.23 ns/pF) C <sub>L</sub>	-	40	80	ns
		see <u>Fig. 5</u>	15 V	22 ns + (0.16 ns/pF) C <sub>L</sub>	-	30	60	ns
t <sub>t</sub>	transition time	see <u>Fig. 5</u>	5 V [3]	10 ns + (1.00 ns/pF) C <sub>L</sub>	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF) C <sub>L</sub>	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF) C <sub>L</sub>	-	20	40	ns
tw	pulse width	minimum width; RS HIGH; see <u>Fig. 5</u>	5 V		120	60	-	ns
			10 V		50	25	-	ns
			15 V		30	15	-	ns
		minimum width;	5 V		50	25	-	ns
		MR HIGH; see <u>Fig. 5</u>	10 V		30	15	-	ns
		see <u>r ig. o</u>	15 V		20	10	-	ns
t <sub>rec</sub>	recovery time	input MR;	5 V		160	80	-	ns
		see <u>Fig. 5</u>	10 V		80	40	-	ns
			15 V		60	30	-	ns
max	maximum frequency	•	5 V		4	8	-	MHz
		see <u>Fig. 5</u>	10 V		10	20	-	MHz
			15 V		15	30	-	MHz

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C<sub>L</sub> in pF).

 $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ . [2]

[3]

#### Table 8. Power dissipation

Dynamic power dissipation  $P_D$  and total power dissipation  $P_{tot}$  can be calculated from the formulas shown.  $T_{amb}$  = 25 °C.

Symbol	Parameter	Conditions	V <sub>DD</sub>	Typical formula for $P_D$ and $P_{tot}$ (µW)[1]	
P <sub>D</sub> dynamic power		per device	5 V	$P_{D} = 700 \text{ x } f_{i} + \sum (f_{o} \text{ x } C_{L}) \text{ x } V_{DD}^{2}$	
	dissipation		10 V	$P_D = 3300 \text{ x } f_i + \sum (f_o \text{ x } C_L) \text{ x } V_{DD}^2$	
			15 V	$P_{D} = 8900 \text{ x } f_{i} + \sum (f_{o} \text{ x } C_{L}) \text{ x } V_{DD}^{2}$	
P <sub>tot</sub>	total power	when using	5 V	$P_{tot} = 700 \text{ x } f_{osc} + \sum (f_o \text{ x } C_L) \text{ x } V_{DD}^2 + 2 \text{ x } C_t \text{ x } V_{DD}^2 \text{ x } f_{osc}$	, + 690 x V <sub>DD</sub>
	dissipation	the on-chip oscillator	10 V	$P_{tot} = 3300 \text{ x } f_{osc} + \sum (f_o \text{ x } C_L) \text{ x } V_{DD}^2 + 2 \text{ x } C_t \text{ x } V_{DD}^2 \text{ x } f_{o}$	<sub>sc</sub> + 6900 x V <sub>DD</sub>
		o som a tor	15 V	$P_{tot} = 8900 \text{ x } f_{osc} + \sum (f_o \text{ x } C_L) \text{ x } V_{DD}^2 + 2 \text{ x } C_t \text{ x } V_{DD}^2 \text{ x } f_o$ $V_{DD}$	<sub>sc</sub> + 22000 x

[1] Where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz;

 $C_{L}$  = output load capacitance in pF;

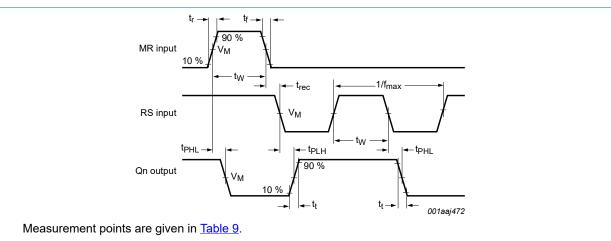
V<sub>DD</sub> = supply voltage in V;

 $\sum (f_o \times C_L) =$ sum of the outputs;

C<sub>t</sub> = timing capacitance (pF);

 $f_{osc}$  = oscillator frequency (MHz).

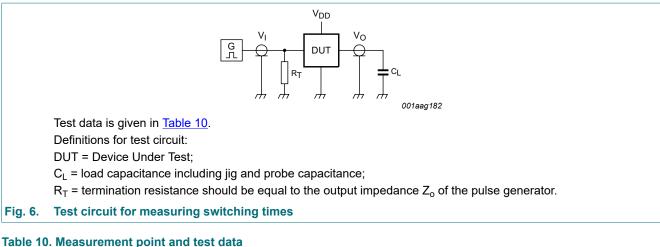




#### Fig. 5. Waveforms showing propagation delays for MR to Qn and CP to Q0, minimum MR, and CP pulse widths

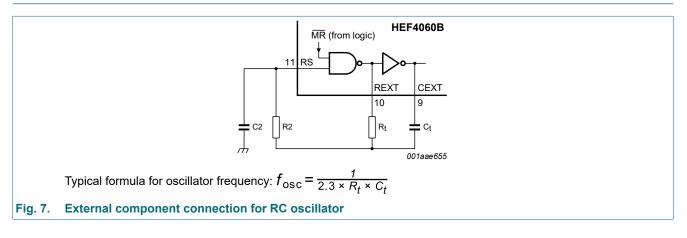
#### Table 9. Measurement points

Supply voltage	Input	Output
V <sub>DD</sub>	V <sub>M</sub>	V <sub>M</sub>
5 V to 15 V	0.5V <sub>DD</sub>	0.5V <sub>DD</sub>



Supply voltage	Input	Load	
V <sub>DD</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL
5 V to 15 V	$V_{SS}$ or $V_{DD}$	≤ 20 ns	50 pF

### 11. RC oscillator



#### 11.1. Timing component limitations

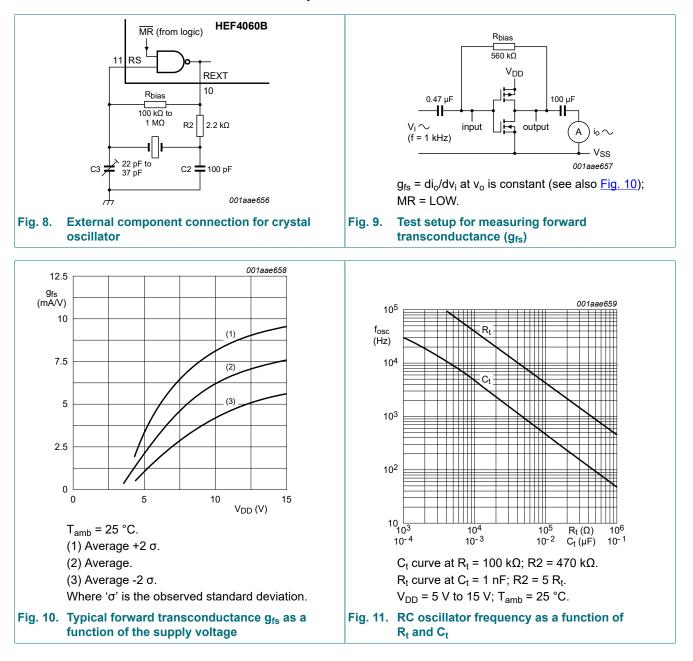
The oscillator frequency is mainly determined by  $R_t \times C_t$ , provided  $R_t << R2$  and  $R2 \times C2 << R_t \times C_t$ . The influence of the forward voltage across the input protection diodes on the frequency is minimized by R2. The stray capacitance C2 should be kept as small as possible. In consideration of accuracy,  $C_t$  must be larger than the inherent stray capacitance.  $R_t$  must be larger than the LOCMOS (Local Oxidation Complementary Metal-Oxide Semiconductor) 'ON' resistance in series with it, which typically is 500  $\Omega$  at  $V_{DD}$  = 5 V, 300  $\Omega$  at  $V_{DD}$  = 10 V and 200  $\Omega$  at  $V_{DD}$  = 15 V.

The recommended values for these components to maintain agreement with the typical oscillation formula are:

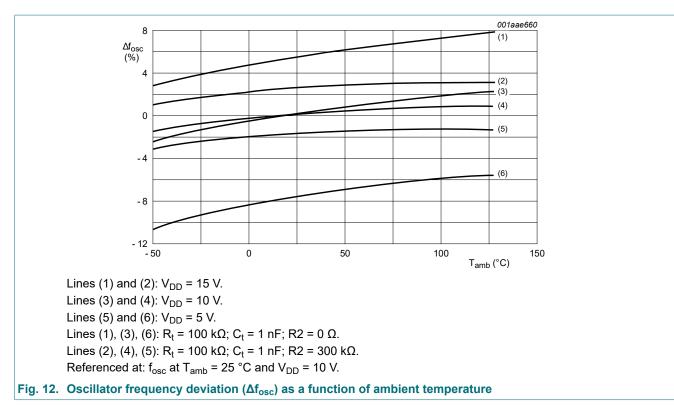
- $C_t \ge 100 \text{ pF}$ , up to any practical value,
- 10 kΩ ≤ R<sub>t</sub> ≤ 1 MΩ.

#### 11.2. Typical crystal oscillator circuit

In Fig. 8, R2 is the power limiting resistor. For starting and maintaining oscillation a minimum transconductance is necessary.

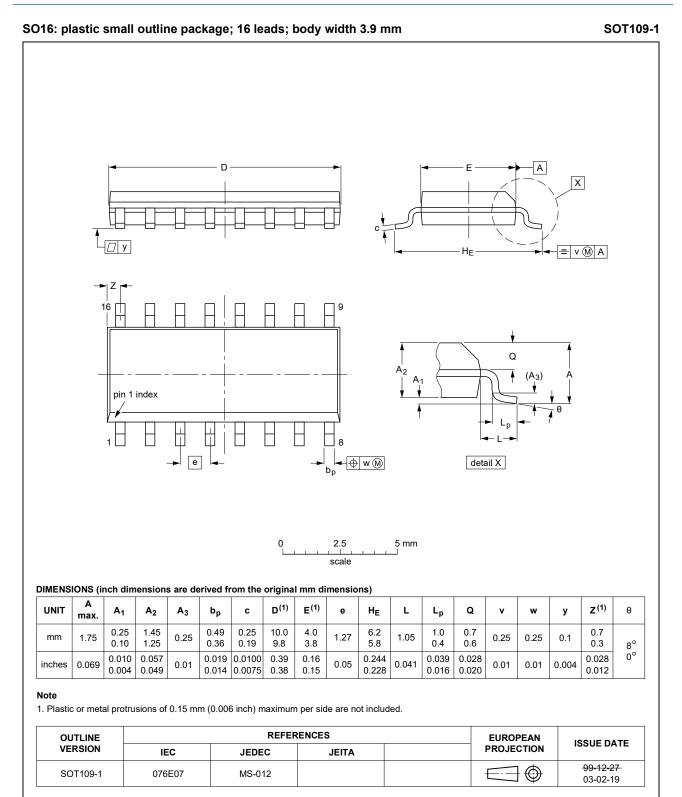


**Product data sheet** 



**Product data sheet** 

### 12. Package outline



#### Fig. 13. Package outline SOT109-1 (SO16)

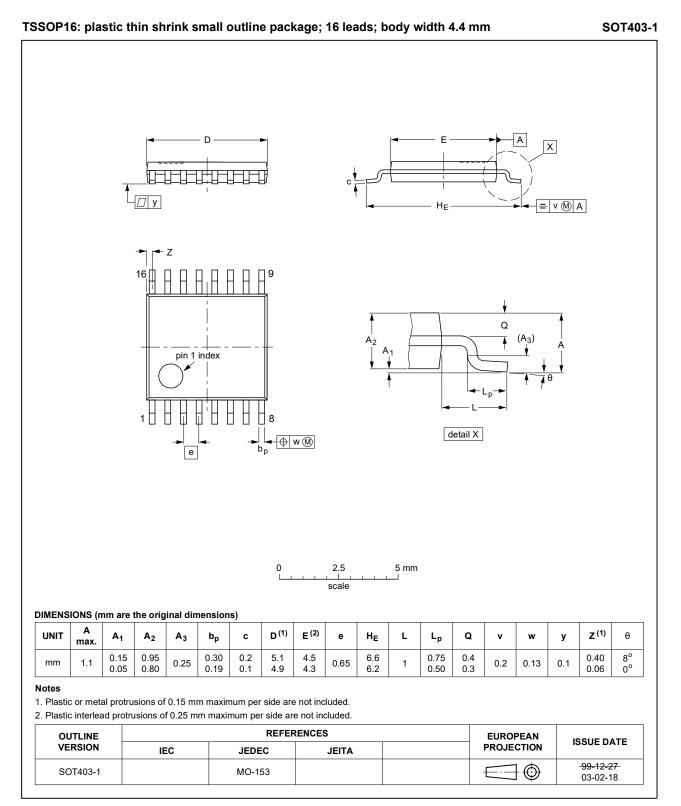


Fig. 14. Package outline SOT403-1 (TSSOP16)

### 13. Abbreviations

Acronym	Description
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

### 14. Revision history

Table 12. Revision history								
Document ID	Release date	Data sheet status	Change notice	Supersedes				
HEF4060B v.10	20211108	Product data sheet	-	HEF4060B v.9				
Modifications:	Nexperia. <ul> <li>Legal texts has</li> </ul>	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li><u>Section 1</u> and <u>Section 2</u> updated.</li> </ul>						
HEF4060B v.9	20190708	Product data sheet	-	HEF4060B v.8				
Modifications:	Type number	HEF4060BTT (SOT403-1/TSS	OP16) added.					
HEF4060B v.8	20160325	Product data sheet	-	HEF4060B v.7				
Modifications:	Type number	HEF4060BP (SOT38-4) remov	ed.					
HEF4060B v.7	20111116	Product data sheet	-	HEF4060B v.6				
Modifications:	Changes in "C	<ul> <li>Legal pages updated.</li> <li>Changes in "General description" and "Features and benefits".</li> <li>Section "Applications" removed.</li> </ul>						
HEF4060B v.6	20110511	Product data sheet	-	HEF4060B v.5				
HEF4060B v.5	20091127	Product data sheet	-	HEF4060B v.4				
HEF4060B v.4	20090817	Product data sheet	-	HEF4060B_CNV v.3				
HEF4060B_CNV v.3	19950101	Product specification	-	HEF4060B_CNV v.2				
HEF4060B_CNV v.2	19950101	Product specification	-	-				

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#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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### Contents

1. General description	1
2. Features and benefits	1
3. Ordering information	1
4. Functional diagram	
5. Pinning information	2
5.1. Pinning	2
5.2. Pin description	3
6. Functional description	3
7. Limiting values	
8. Recommended operating conditions	4
9. Static characteristics	
10. Dynamic characteristics	5
10.1. Waveforms and test circuit	6
11. RC oscillator	
11.1. Timing component limitations	7
11.2. Typical crystal oscillator circuit	
12. Package outline	
13. Abbreviations	12
14. Revision history	
15. Legal information	
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